FlipChip International Receives ISO 9001-2000 Certification

PHOENIX, Arizona, October 1, 2004--- FlipChip International, LLC announced today the successful ISO 9001-2000 certification of its Phoenix, Arizona semiconductor wafer bumping and wafer level packaging business.   ISO is an internationally recognized accreditation organization focused on world class quality management systems. FlipChip's certification process was administered by SGS Systems and Services.

Bruce Bowers, Vice President of Operations stated "This ISO 9001-2000 certification is another achievement by FCI and shows our commitment to established quality and business systems to serve our expanding customer base. The ISO 9001-2000 requirements are directed at the support of customers and our energy at FCI aligns well with this high standard.   I am extremely pleased with our progress in reaching this goal in our first six month's of operation. We are improving FCI daily and this certificate validates the progress being made".

FlipChip International, LLC (FCI) is a privately held supplier of products and services for the wafer bumping and wafer level packaging semiconductor market. FlipChip International, LLC is a wholly owned subsidiary of RoseStreet Labs, LLC, a supplier of products and services for wireless infrastructure in the life science, renewable energy and homeland security markets.

For further information contact:
Stephanie Sarabia
FlipChip International, LLC
 602-431-4747
ssarabia@flipchip.com
website: www.flipchip.com